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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	21
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx110f016b-v-ss

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 5: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES

28-PIN QFN (TOP VIEW)^(1,2,3.4)

PIC32MX110F016B PIC32MX120F032B PIC32MX130F064B PIC32MX130F256B PIC32MX150F128B PIC32MX170F256B

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Pin #	Full Pin Name	Pin #	Full Pin Name
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	16	Vss
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	17	VCAP
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	18	PGED2/RPB10/CTED11/PMD2/RB10
5	Vss	19	PGEC2/TMS/RPB11/PMD1/RB11
6	OSC1/CLKI/RPA2/RA2	20	AN12/PMD0/RB12
7	OSC2/CLKO/RPA3/PMA0/RA3	21	AN11/RPB13/CTPLS/PMRD/RB13
8	SOSCI/RPB4/RB4	22	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
10	Vdd	24	AVss
11	PGED3/RPB5/PMD7/RB5	25	AVDD
12	PGEC3/RPB6/PMD6/RB6	26	MCLR
13	TDI/RPB7/CTED3/PMD5/INT0/RB7	27	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8	28	VREF-/CVREF-/AN1/RPA1/CTED2/RA1

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: Shaded pins are 5V tolerant.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	—	_	_	—	_	—	_	—	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16	—	—	_	—	_	—	—	—	
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	
15:8	BMXDUDBA<15:8>								
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
				BMXDU	DBA<7:0>				

REGISTER 4-3: BMXDUDBA: DATA RAM USER DATA BASE ADDRESS REGISTER

Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 BMXDUDBA<15:10>: DRM User Data Base Address bits

When non-zero, the value selects the relative base address for User mode data space in RAM, the value must be greater than BMXDKPBA.

bit 9-0 BMXDUDBA<9:0>: Read-Only bits This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	_	—	—		_	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	—	—	—	—	—
45.0	R/W-0	R/W-0	R-0	R-0	R-0	U-0	U-0	U-0
15:8	WR	WREN	WRERR ⁽¹⁾	LVDERR ⁽¹⁾	LVDSTAT ⁽¹⁾		_	
7.0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	—		—	NVMOP<3:0>			

REGISTER 5-1: NVMCON: PROGRAMMING CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re-	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

011 31-10	Unimplemented. Read as 0
bit 15	WR: Write Control bit
	This bit is writable when WREN = 1 and the unlock sequence is followed.
	1 = Initiate a Flash operation. Hardware clears this bit when the operation completes
	0 = Flash operation is complete or inactive
bit 14	WREN: Write Enable bit
	This is the only bit in this register reset by a device Reset.
	1 = Enable writes to WR bit and enables LVD circuit
	0 = Disable writes to WR bit and disables LVD circuit
bit 13	WRERR: Write Error bit ⁽¹⁾
	This bit is read-only and is automatically set by hardware.
	1 = Program or erase sequence did not complete successfully
	0 = Program or erase sequence completed normally
bit 12	LVDERR: Low-Voltage Detect Error bit (LVD circuit must be enabled) ⁽¹⁾
	This bit is read-only and is automatically set by hardware.
	1 = Low-voltage detected (possible data corruption, if WRERR is set)
	0 = Voltage level is acceptable for programming
bit 11	LVDSTAT: Low-Voltage Detect Status bit (LVD circuit must be enabled) ⁽¹⁾
	This bit is read-only and is automatically set and cleared by the hardware.
	1 = Low-voltage event is active
hit 10 1	0 = Low-voltage event is not active
bit 10-4 bit 3-0	Unimplemented: Read as '0'
0-6 110	NVMOP<3:0>: NVM Operation bits These bits are writable when WREN = 0.
	1111 = Reserved
	•
	•
	0111 = Reserved 0110 = No operation
	0101 = Program Flash Memory (PFM) erase operation: erases PFM, if all pages are not write-protected
	0100 = Page erase operation: erases page selected by NVMADDR, if it is not write-protected
	0011 = Row program operation: programs row selected by NVMADDR, if it is not write-protected
	0010 = No operation
	0001 = Word program operation: programs word selected by NVMADDR, if it is not write-protected 0000 = No operation

Note 1: This bit is cleared by setting NVMOP == `b0000, and initiating a Flash operation (i.e., WR).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	U-0	U-0						
31:24	_	_	_	_	_		-	—
22:16	U-0	U-0						
23:16	_	_	_	_	_		-	—
45.0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0, HS	R/W-0
15:8		_	—	-	_	_	CMR	VREGS
	R/W-0, HS	R/W-0, HS	U-0	R/W-0, HS	R/W-0, HS	R/W-0, HS	R/W-1, HS	R/W-1, HS
7:0	EXTR	SWR	_	WDTO	SLEEP	IDLE	BOR ⁽¹⁾	POR ⁽¹⁾

REGISTER 6-1: RCON: RESET CONTROL REGISTER

Legend:	HS = Set by hardware		
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-10 Unimplemented: Read as '0'

bit 9	CMR: Configuration Mismatch Reset Flag bit
	1 = Configuration mismatch Reset has occurred
	0 = Configuration mismatch Reset has not occurred
bit 8	VREGS: Voltage Regulator Standby Enable bit
	1 = Regulator is enabled and is on during Sleep mode
	0 = Regulator is disabled and is off during Sleep mode
bit 7	EXTR: External Reset (MCLR) Pin Flag bit
	1 = Master Clear (pin) Reset has occurred
	0 = Master Clear (pin) Reset has not occurred
bit 6	SWR: Software Reset Flag bit
	1 = Software Reset was executed
	0 = Software Reset as not executed
bit 5	Unimplemented: Read as '0'
bit 4	WDTO: Watchdog Timer Time-out Flag bit
	1 = WDT Time-out has occurred
	0 = WDT Time-out has not occurred
bit 3	SLEEP: Wake From Sleep Flag bit
	1 = Device was in Sleep mode
	0 = Device was not in Sleep mode
bit 2	IDLE: Wake From Idle Flag bit
	1 = Device was in Idle mode
	0 = Device was not in Idle mode
bit 1	BOR: Brown-out Reset Flag bit ⁽¹⁾
	1 = Brown-out Reset has occurred
	0 = Brown-out Reset has not occurred
bit 0	POR: Power-on Reset Flag bit ⁽¹⁾
	1 = Power-on Reset has occurred
	0 = Power-on Reset has not occurred

Note 1: User software must clear this bit to view next detection.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_		_	_	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_		_	_	_	—	—
45.0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
15:8	—	_	—	MVEC	_		TPC<2:0>	
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	_	_	_	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Legend:

Logona.					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-16 Unimplemented: Read as '0'

bit 15-13 Unimplemented: Read as '0'

- bit 12 MVEC: Multi Vector Configuration bit
 - 1 = Interrupt controller configured for Multi-vectored mode
 - 0 = Interrupt controller configured for Single-vectored mode
- bit 11 Unimplemented: Read as '0'
- bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits
 - 111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
 - 110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
 - 101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
 - 100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
 - 011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
 - 010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
 - 001 = Interrupts of group priority 1 start the Interrupt Proximity timer
 - 000 = Disables Interrupt Proximity timer

bit 7-5 Unimplemented: Read as '0'

- bit 4 INT4EP: External Interrupt 4 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 3 INT3EP: External Interrupt 3 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 2 INT2EP: External Interrupt 2 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 1 INT1EP: External Interrupt 1 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 0 INTOEP: External Interrupt 0 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
31:24	DCRCDATA<31:24>												
00.10	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
23:16	DCRCDATA<23:16>												
15.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
15:8	DCRCDATA<15:8>												
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0	DCRCDATA<7:0>												

REGISTER 9-5: DCRCDATA: DMA CRC DATA REGISTER

Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 DCRCDATA<31:0>: CRC Data Register bits

Writing to this register will seed the CRC generator. Reading from this register will return the current value of the CRC. Bits greater than PLEN will return '0' on any read.

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): Only the lower 16 bits contain IP header checksum information. The upper 16 bits are always '0'. Data written to this register is converted and read back in 1's complement form (i.e., current IP header checksum value).

<u>When CRCTYP (DCRCCON<15>) = 0</u> (CRC module is in LFSR mode): Bits greater than PLEN will return '0' on any read.

REGISTER 9-6: DCRCXOR: DMA CRCXOR ENABLE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
24.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
31:24	DCRCXOR<31:24>												
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
23:16	DCRCXOR<23:16>												
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
15:8	DCRCXOR<15:8>												
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0	DCRCXOR<7:0>												

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 DCRCXOR<31:0>: CRC XOR Register bits

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): This register is unused.

When CRCTYP (DCRCCON<15>) = 0 (CRC module is in LFSR mode):

- 1 = Enable the XOR input to the Shift register
- 0 = Disable the XOR input to the Shift register; data is shifted in directly from the previous stage in the register

11.1 Parallel I/O (PIO) Ports

All port pins have 10 registers directly associated with their operation as digital I/O. The data direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx) read the latch. Writes to the latch write the latch. Reads from the port (PORTx) read the port pins, while writes to the port pins write the latch.

11.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx, and TRISx registers for data control, some port pins can also be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired 5V-tolerant pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

See the **"Pin Diagrams"** section for the available pins and their functionality.

11.1.2 CONFIGURING ANALOG AND DIGITAL PORT PINS

The ANSELx register controls the operation of the analog port pins. The port pins that are to function as analog inputs must have their corresponding ANSEL and TRIS bits set. In order to use port pins for I/O functionality with digital modules, such as Timers, UARTs, etc., the corresponding ANSELx bit must be cleared.

The ANSELx register has a default value of 0xFFFF; therefore, all pins that share analog functions are analog (not digital) by default.

If the TRIS bit is cleared (output) while the ANSELx bit is set, the digital output level (VOH or VOL) is converted by an analog peripheral, such as the ADC module or Comparator module.

When the PORT register is read, all pins configured as analog input channels are read as cleared (a low level).

Pins configured as digital inputs do not convert an analog input. Analog levels on any pin defined as a digital input (including the ANx pins) can cause the input buffer to consume current that exceeds the device specifications.

11.1.3 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically this instruction would be a NOP.

11.1.4 INPUT CHANGE NOTIFICATION

The input change notification function of the I/O ports allows the PIC32MX1XX/2XX 28/36/44-pin Family devices to generate interrupt requests to the processor in response to a change-of-state on selected input pins. This feature can detect input change-of-states even in Sleep mode, when the clocks are disabled. Every I/O port pin can be selected (enabled) for generating an interrupt request on a change-of-state.

Five control registers are associated with the CN functionality of each I/O port. The CNENx registers contain the CN interrupt enable control bits for each of the input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

The CNSTATx register indicates whether a change occurred on the corresponding pin since the last read of the PORTx bit.

Each I/O pin also has a weak pull-up and a weak pull-down connected to it. The pull-ups act as a current source or sink source connected to the pin, and eliminate the need for external resistors when push-button or keypad devices are connected. The pull-ups and pull-downs are enabled separately using the CNPUx and the CNPDx registers, which contain the control bits for each of the pins. Setting any of the control bits enables the weak pull-ups and/or pull-downs for the corresponding pins.

Note: Pull-ups and pull-downs on change notification pins should always be disabled when the port pin is configured as a digital output.

An additional control register (CNCONx) is shown in Register 11-3.

11.2 CLR, SET and INV Registers

Every I/O module register has a corresponding CLR (clear), SET (set) and INV (invert) register designed to provide fast atomic bit manipulations. As the name of the register implies, a value written to a SET, CLR or INV register effectively performs the implied operation, but only on the corresponding base register and only bits specified as '1' are modified. Bits specified as '0' are not modified.

Reading SET, CLR and INV registers returns undefined values. To see the affects of a write operation to a SET, CLR, or INV register, the base register must be read.

TABLE 11-5: PORTC REGISTER MAP

ess	-											Bits							<i>"</i>
Virtual Address (BF88_#)	Register Name ^(1,2)	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6200	ANSELC	31:16		_			—	—	_	-	_	-	_	_	—	_	—		0000
0200	,	15:0	—	—	—	—	—	—			—			_	ANSC3(4)	ANSC2 ⁽³⁾	ANSC1	ANSC0	000F
6210	TRISC	31:16	_	_	—	—	—	—	—	—	—	—	—	—	—	—	—		0000
0210	11100	15:0	_	_	—	—	—	—	TRISC9	TRISC8 ⁽³⁾	TRISC7 ⁽³⁾	TRISC6 ⁽³⁾	TRISC5 ⁽³⁾	TRISC4 ⁽³⁾	TRISC3	TRISC2 ⁽³⁾	TRISC1	TRISC0	03FF
6220	PORTC	31:16	—	—	—	—	—	—	_		_		_						0000
0220		15:0	_	_	—	—	—	—	RC9	RC8 ⁽³⁾	RC7 ⁽³⁾	RC6 ⁽³⁾	RC5 ⁽³⁾	RC4 ⁽³⁾	RC3	RC2 ⁽³⁾	RC1	RC0	xxxx
6230	LATC	31:16	_	_	—	—	—	—	_		_			_	—		—	—	0000
0230	LAIC	15:0			_	_	_	_	LATC9	LATC8 ⁽³⁾	LATC7 ⁽³⁾	LATC6 ⁽³⁾	LATC5 ⁽³⁾	LATC4 ⁽³⁾	LATC3	LATC2 ⁽³⁾	LATC1	LATC0	xxxx
6240	ODCC	31:16			_	_	_	_	_						_		_	_	0000
6240	ODCC	15:0			_	_	_	_	ODCC9	ODCC8 ⁽³⁾	ODCC7 ⁽³⁾	ODCC6 ⁽³⁾	ODCC5 ⁽³⁾	ODCC4 ⁽³⁾	ODCC3	ODCC2 ⁽³⁾	ODCC1	ODCC0	0000
0050		31:16			—	—	—	-	—	-	_	-	—	—	—	—	—	—	0000
6250	CNPUC	15:0	_	_	_	_	—	—	CNPUC9	CNPUC8 ⁽³⁾	CNPUC7 ⁽³⁾	CNPUC6 ⁽³⁾	CNPUC5 ⁽³⁾	CNPUC4 ⁽³⁾	CNPUC3	CNPUC2 ⁽³⁾	CNPUC1	CNPUC0	0000
0000		31:16	_	_	_	_	_	_	—	_	_	_	_	—	_	—	_	_	0000
6260	CNPDC	15:0	_	_	—	_	—	—	CNPDC9	CNPDC8 ⁽³⁾	CNPDC7 ⁽³⁾	CNPDC6 ⁽³⁾	CNPDC5 ⁽³⁾	CNPDC4 ⁽³⁾	CNPDC3	CNPDC2 ⁽³⁾	CNPDC1	CNPDC0	0000
0070	anaana	31:16	_	_	—	_	—	—	_	_	_	_	—	—	—	_	—	—	0000
6270	CNCONC	15:0	ON	_	SIDL	_	—	—	_	_	_	_	_	—	_	_	—	_	0000
		31:16	_	_	_		—	_			_		_	_	_	_	—	—	0000
6280	CNENC	15:0	_	_	_		—	_	CNIEC9	CNIEC8(3)	CNIEC7 ⁽³⁾	CNIEC6(3)	CNIEC5 ⁽³⁾	CNIEC4 ⁽³⁾	CNIEC3	CNIEC2 ⁽³⁾	CNIEC1	CNIEC0	0000
		31:16	_	_	_	_	_	_	_		_		_	_	—		—	—	0000
6290	CNSTATC	15:0	_	_	_	_	_	_	CNSTATC9	CNSTATC8(3)	CNSTATC7 ⁽³⁾	CNSTATC6(3)	CNSTATC5(3)	CNSTATC4 ⁽³⁾	CNSTATC3	CNSTATC2(3)	CNSTATC1	CNSTATC0	0000

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: PORTC is not available on 28-pin devices.

3: This bit is only available on 44-pin devices.

4: This bit is only available on USB-enabled devices with 36 or 44 pins.

TABLE 11-6: PERIPHERAL PIN SELECT INPUT REGISTER MAP

ssa										В	its								
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
FA04	INT1R	31:16					_	_								_			0000
FA04		15:0	—	—	—	—	—	—	—	—	—	—	—	—		INT1F	R<3:0>		0000
FA08	INT2R	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	_	—	—	0000
FAUO	INTZR	15:0	—	—	—	—	—	—	—	—	—	—	—	—		INT2F	R<3:0>		0000
FA0C	INT3R	31:16	_	_	_	_	—	—	_	_	—	_		—	_		—	—	0000
FAUC	IN I 3R	15:0		_	_	_	_	_	_	_	_	_	_	_		INT3F	R<3:0>		0000
5440		31:16		_	_	_	_	_	_	_	_	_	_	_	_	_	_	-	0000
FA10	INT4R	15:0	-	_	_	_	—	—	_	_	_	_	_	_		INT4F	R<3:0>		0000
5440	TAOKA	31:16	_	_	_	_	—	—	_	_	_	_	_	_	_	_	_	—	0000
FA18	T2CKR	15:0	_	_	_	_	_	_	_	_	_	_	_	_		T2CK	R<3:0>		0000
		31:16	_	_	_	_	_	_	_	_	_	_		_	_		_	_	0000
FA1C	T3CKR	15:0	_	_	_	_	_	_	_	_	_	_		_		T3CK	R<3:0>	•	0000
		31:16	_	_	_	_	_	_	_	_	_	_		_	_		_	_	0000
FA20	T4CKR	15:0			_		_	_	_	_	_			_		T4CK	R<3:0>	•	0000
		31:16			_		_	_	_	_	_			_	_		_	_	0000
FA24	T5CKR	15:0	_	_	_	_	_	_	_	_	_	_	_	_		T5CK	R<3:0>		0000
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	_		—	_	0000
FA28	IC1R	15:0	_	_	_		_	_	_	_	_	_	_	_		IC1R	<3:0>		0000
		31:16	_		_	_	_	_	_	_	_		_		_	_	_	_	0000
FA2C	IC2R	15:0	_		_	_	_	_	_	_	_		_			IC2R	<3:0>		0000
		31:16	_	_	_		_	_	_	_	_	_	_	_		_	_	_	0000
FA30	IC3R	15:0	_	_	_		_	_	_	_	_	_	_	_		IC3R	<3:0>		0000
		31:16	_		_	_	_	_	_	_	_		_		_	_	_	_	0000
FA34	IC4R	15:0	_		_	_	_	_	_	_	_		_			IC4R	<3:0>		0000
		31:16	_		_	_	_	_	_	_	_		_		_	_	_	_	0000
FA38	IC5R	15:0	_	_	_	_	_	_	_	_	_	_	_	_		IC5R	<3:0>		0000
		31:16	_	_			_	_		_	_	_	_	_		_		_	0000
FA48	OCFAR	15:0	_	_	_	_	_	_	_	_	_	_	_	_		OCFA	R<3:0>		0000
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
FA4C	OCFBR	15:0	_	_	_	_	_	_	_	_	_	_	_	_		OCFB	R<3:0>		0000
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
FA50	U1RXR	15:0	_	_	_	_	_	_	_	_	_	_	_	_		U1RX	R<3:0>		0000

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

12.2 Timer1 Control Registers

TABLE 12-1: TIMER1 REGISTER MAP

ess		0								В	its								s
Virtual Addre (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
0600	T1CON	31:16	_	_	_	_	_	—	_	—	_	—	—	—	_	—	_	_	0000
0600	TICON	15:0	ON	—	SIDL	TWDIS	TWIP	—	_	—	TGATE	_	TCKPS	S<1:0>	—	TSYNC	TCS	_	0000
0610	TMR1	31:16	—	-	—	—	—	—	—	—	—	—	_	_	—	—	—	—	0000
0010		15:0								TMR1	<15:0>								0000
0620	PR1	31:16	—	_	_	_	_	—	-	—	—	_	—	_	_	_	_		0000
0020	FRI	15:0								PR1<	:15:0>								FFFF

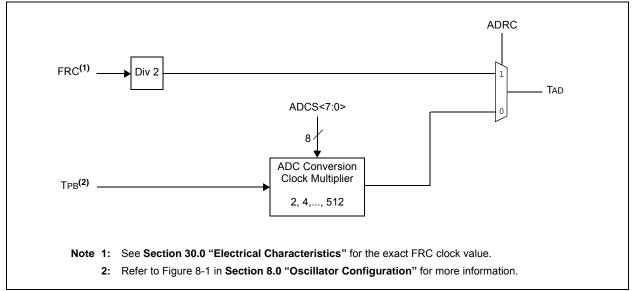
Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

REGISTE	R 18-1:	I2CxCON: I ² C CONTROL REGISTER (CONTINUED)
bit 7	GCEN: Ge	eneral Call Enable bit (when operating as I ² C slave)
	(module	interrupt when a general call address is received in the I2CxRSR e is enabled for reception)
		al call address is disabled
bit 6	STREN: S	CLx Clock Stretch Enable bit (when operating as I ² C slave)
		njunction with SCLREL bit.
		e software or receive clock stretching
L:1 F		e software or receive clock stretching
bit 5		cknowledge Data bit (when operating as I ² C master, applicable during master receive) is transmitted when the software initiates an Acknowledge sequence.
		a NACK during an Acknowledge sequence
		an ACK during an Acknowledge sequence
bit 4	ACKEN: A receive)	cknowledge Sequence Enable bit (when operating as I ² C master, applicable during master
	Hardwa	Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. are clear at end of master Acknowledge sequence. wledge sequence not in progress
bit 3	RCEN: Re	ceive Enable bit (when operating as I ² C master)
		es Receive mode for I ² C. Hardware clear at end of eighth bit of master receive data byte. The sequence not in progress
bit 2	PEN: Stop	Condition Enable bit (when operating as I ² C master)
		Stop condition on SDAx and SCLx pins. Hardware clear at end of master Stop sequence. ondition not in progress
bit 1	RSEN: Re	peated Start Condition Enable bit (when operating as I ² C master)
		Repeated Start condition on SDAx and SCLx pins. Hardware clear at end of Repeated Start sequence.
	0 = Repeat	ted Start condition not in progress
bit 0		Condition Enable bit (when operating as I ² C master)
		Start condition on SDAx and SCLx pins. Hardware clear at end of master Start sequence. ondition not in progress

Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.





Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	—	—	—	—	—
45.0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0
15:8		VCFG<2:0>		OFFCAL	—	CSCNA	—	—
7.0	R-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	BUFS			SMP	BUFM	ALTS		

REGISTER 22-2: AD1CON2: ADC CONTROL REGISTER 2

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-13 VCFG<2:0>: Voltage Reference Configuration bits

	VREFH	VREFL
000	AVDD	AVss
001	External VREF+ pin	AVss
010	AVdd	External VREF- pin
011	External VREF+ pin	External VREF- pin
1xx	AVdd	AVss

bit 12 **OFFCAL:** Input Offset Calibration Mode Select bit

1 = Enable Offset Calibration mode

Positive and negative inputs of the sample and hold amplifier are connected to VREFL

0 = Disable Offset Calibration mode

The inputs to the sample and hold amplifier are controlled by AD1CHS or AD1CSSL

bit 11 Unimplemented: Read as '0'

- bit 10 **CSCNA:** Input Scan Select bit
 - 1 = Scan inputs

0 = Do not scan inputs

bit 9-8 **Unimplemented:** Read as '0'

bit 7 **BUFS:** Buffer Fill Status bit

Only valid when BUFM = 1.

1 = ADC is currently filling buffer 0x8-0xF, user should access data in 0x0-0x7

0 = ADC is currently filling buffer 0x0-0x7, user should access data in 0x8-0xF

bit 6 Unimplemented: Read as '0'

bit 5-2 SMPI<3:0>: Sample/Convert Sequences Per Interrupt Selection bits

```
1111 = Interrupts at the completion of conversion for each 16<sup>th</sup> sample/convert sequence
```

1110 = Interrupts at the completion of conversion for each 15th sample/convert sequence

- •

0001 = Interrupts at the completion of conversion for each 2nd sample/convert sequence 0000 = Interrupts at the completion of conversion for each sample/convert sequence

bit 1 BUFM: ADC Result Buffer Mode Select bit

- 1 = Buffer configured as two 8-word buffers, ADC1BUF7-ADC1BUF0, ADC1BUFF-ADCBUF8
 - 0 = Buffer configured as one 16-word buffer ADC1BUFF-ADC1BUF0

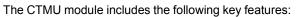
bit 0 ALTS: Alternate Input Sample Mode Select bit

- 1 = Uses Sample A input multiplexer settings for first sample, then alternates between Sample B and Sample A input multiplexer settings for all subsequent samples
- 0 = Always use Sample A input multiplexer settings

25.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

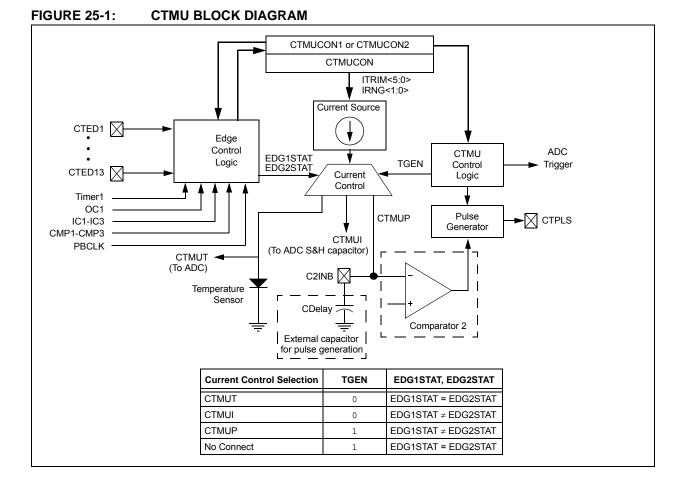
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 37. "Charge Time Measurement Unit (CTMU)" (DS60001167), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Charge Time Measurement Unit (CTMU) is a flexible analog module that has a configurable current source with a digital configuration circuit built around it. The CTMU can be used for differential time measurement between pulse sources and can be used for generating an asynchronous pulse. By working with other on-chip analog modules, the CTMU can be used for high resolution time measurement, measure capacitance, measure relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.



- Up to 13 channels available for capacitive or time measurement input
- · On-chip precision current source
- 16-edge input trigger sources
- · Selection of edge or level-sensitive inputs
- · Polarity control for each edge source
- Control of edge sequence
- Control of response to edges
- · High precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- · Integrated temperature sensing diode
- · Control of current source during auto-sampling
- · Four current source ranges
- · Time measurement resolution of one nanosecond

A block diagram of the CTMU is shown in Figure 25-1.



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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	_	_	_		_	—
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	-	—	_	_	-	—
45.0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
15:8	—	—	IOLOCK ⁽¹⁾	PMDLOCK ⁽¹⁾				—
7.0	U-0	U-0	U-0	U-0	R/W-1	U-0	U-1	R/W-1
7:0	_			_	JTAGEN		_	TDOEN

REGISTER 27-5: CFGCON: CONFIGURATION CONTROL REGISTER

Legend:

Logona.				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-14 Unimplemented: Read as '0'

- bit 13 IOLOCK: Peripheral Pin Select Lock bit⁽¹⁾
 - 1 = Peripheral Pin Select is locked. Writes to PPS registers is not allowed.
 - 0 = Peripheral Pin Select is not locked. Writes to PPS registers is allowed.
- bit 12 PMDLOCK: Peripheral Module Disable bit⁽¹⁾
 - 1 = Peripheral module is locked. Writes to PMD registers is not allowed.
 - 0 = Peripheral module is not locked. Writes to PMD registers is allowed.

bit 11-4 Unimplemented: Read as '0'

- bit 3 JTAGEN: JTAG Port Enable bit
 - 1 = Enable the JTAG port
 - 0 = Disable the JTAG port
- bit 2-1 Unimplemented: Read as '1'
- bit 0 **TDOEN:** TDO Enable for 2-Wire JTAG bit
 - 1 = 2-wire JTAG protocol uses TDO
 - 0 = 2-wire JTAG protocol does not use TDO
- Note 1: To change this bit, the unlock sequence must be performed. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

29.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- · Rich directive set
- Flexible macro language
- · MPLAB X IDE compatibility

29.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel[®] standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- · Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

29.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

29.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- Command-line interface
- · Rich directive set
- Flexible macro language
- · MPLAB X IDE compatibility

FIGURE 30-23: EJTAG TIMING CHARACTERISTICS

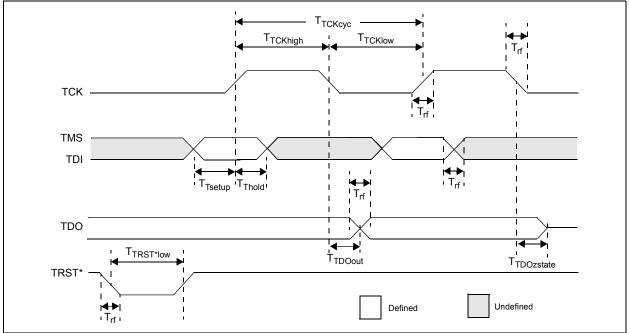


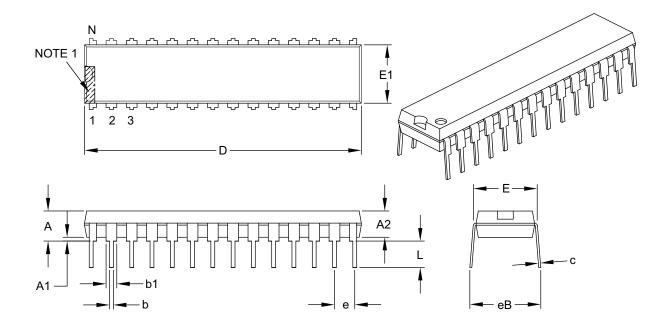
TABLE 30-42: EJTAG TIMING REQUIREMENTS

AC CHARACTERISTICS		$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Description ⁽¹⁾	Min.	Max.	Units	Conditions
EJ1	Ттсксус	TCK Cycle Time	25		ns	_
EJ2	Ттскнідн	TCK High Time	10	_	ns	—
EJ3	TTCKLOW	TCK Low Time	10	_	ns	_
EJ4	TTSETUP	TAP Signals Setup Time Before Rising TCK	5	_	ns	_
EJ5	TTHOLD	TAP Signals Hold Time After Rising TCK	3	-	ns	—
EJ6	Ττροουτ	TDO Output Delay Time from Falling TCK	-	5	ns	—
EJ7	TTDOZSTATE	TDO 3-State Delay Time from Falling TCK	_	5	ns	_
EJ8	TTRSTLOW	TRST Low Time	25		ns	
EJ9	Trf	TAP Signals Rise/Fall Time, All Input and Output	—	_	ns	_

Note 1: These parameters are characterized, but not tested in manufacturing.

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES		
Dimension	n Limits	MIN	NOM	MAX	
Number of Pins	Ν	28			
Pitch	е	.100 BSC			
Top to Seating Plane	Α	-	-	.200	
Molded Package Thickness	A2	.120	.135	.150	
Base to Seating Plane	A1	.015	-	-	
Shoulder to Shoulder Width	Е	.290	.310	.335	
Molded Package Width	E1	.240	.285	.295	
Overall Length	D	1.345	1.365	1.400	
Tip to Seating Plane	L	.110	.130	.150	
Lead Thickness	С	.008	.010	.015	
Upper Lead Width	b1	.040	.050	.070	
Lower Lead Width	b	.014	.018	.022	
Overall Row Spacing §	eB	-	-	.430	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

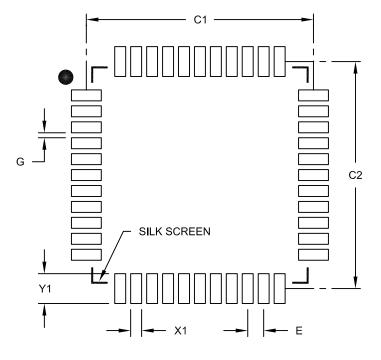
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.80 BSC		
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B

Revision J (April 2016)

This revision includes the following major changes as described in Table A-8, as well as minor updates to text and formatting, which were incorporated throughout the document.

TABLE A-8: MAJOR SECTION UPDATES

Section	Update Description		
"32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	The PIC32MX270FDB device and Note 4 were added to TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" .		
2.0 "Guidelines for Getting Started with 32-bit MCUs"	EXAMPLE 2-1: "Crystal Load Capacitor Calculation" was updated.		
30.0 "Electrical Characteristics"	Parameter DO50a (Csosc) was removed from the Capacitive Loading Requirements on Output Pins AC Characteristics (see Table 30-16).		
"Product Identification System"	The device mapping was updated to include type B for Software Targeting.		